

Electronic Acknowledgement Receipt

EFS ID:	1235931
Application Number:	10599661
Confirmation Number:	2432
Title of Invention:	Palladium-plated Lead Finishing Structure For Semiconductor Part And Method Of Producing Semiconductor Device
First Named Inventor:	Kazumitsu Seki
Customer Number:	54205
Filer:	Joseph A. Calvaruso/Maria Staiano
Filer Authorized By:	Joseph A. Calvaruso
Attorney Docket Number:	17314018
Receipt Date:	04-OCT-2006
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Application Type:	U.S. National Stage under 35 USC 371
International Application Number:	PCT/JP05/09286

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Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		17314018application.pdf	266807	yes	14

	Multipart Description			
	Doc Desc	Start	End	
	Specification - Not in English	1	9	
	Claims	10	11	
	Abstract	12	12	
	Drawings	13	14	

Warnings:

Information:

2	Specification	17314018englishtranslation.pdf	124553	no	15
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Warnings:

Information:

3	Transmittal letter	17314018appltrans.pdf	53880	no	2
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Warnings:

Information:

4	Application Data Sheet	17314018coversheet.pdf	99522	no	4
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5	Documents submitted with 371 Applications	17314018pctrequest.pdf	133622	no	5
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Information:

6	Documents submitted with 371 Applications	17314018pctnotice.pdf	113394	no	4
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Warnings:

Information:

7	Information Disclosure Statement (IDS) Filed	17314018ids.pdf	60897	no	4
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8	Foreign Reference	17314018jp11204713.pdf	302414	no	6
Warnings:					
Information:					
9	Foreign Reference	17314018jp11317487.pdf	434707	no	9
Warnings:					
Information:					
10	Foreign Reference	17314018jp04115558.pdf	331921	no	8
Warnings:					
Information:					
11	Foreign Reference	17314018ep0474499.pdf	124088	no	6
Warnings:					
Information:					
12	Oath or Declaration filed	17314018declaration.pdf	149488	no	4
Warnings:					
Information:					
13	Fee Worksheet (PTO-875)	fee-info.pdf	8537	no	2
Warnings:					
Information:					
Total Files Size (in bytes):					2203830
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